

Part Number: 73660-0000



Status: Active - Custom Series: 73660

Category: Backplane Connectors

HDM® Overview:

Series image - Reference only

Mates With Part(s):

73644 HDM® Board-to-Board Backplane Header 73799 HDM® Board-to-Board Duckpin Midplane Header

Product Environmental Compliance

EU RoHS: Compliance Status Not Reviewed

China RoHS:

REACH SVHC: Not Reviewed Low-Halogen Status: Not Reviewed

Part Detail

General

Status Active - Custom Category Backplane Connectors Series <u>73660</u> Application Daughtercard Comments Key Direction A Component Type Guide Overview **HDM®** HDM® Product Name Style N/A

Physical

Circuits (Loaded) N/A Circuits (maximum) Color - Resin Black Durability (mating cycles max) 250 First Mate / Last Break No Guide to Mating Part No Keying to Mating Part Yes Material - Metal Stainless Steel Material - Plating Mating n/a

Material - Resin High Temperature Thermoplastic

Number of Columns N/A

Number of Pairs Open Pin Field Number of Rows Orientation Right Angle PC Tail Length N/A PCB Locator Yes PCB Retention None PCB Thickness - Recommended 1.60mm Packaging Type Tube Pitch - Mating Interface 2.00mm Pitch - Termination Interface 2.00mm Polarized to PCB Yes Stackable No

Surface Mount Compatible (SMC) No Temperature Range - Operating -55°C to +105°C

Electrical

(Please review the Product Specification for specific details.)

Current - Maximum per Contact 1A Data Rate N/A Real Signals (per 25mm) 75 Shielded No Voltage - Maximum 250V

Material Info

800755024869

Reference - Drawing Numbers

SDA-73660-*** Sales Drawing

Application Tooling

Application Tooling

Tooling specifications and manuals are found by selecting the products below.

Crimp Height Specifications are then contained in the Application Tooling Specification document.

Previously Available Application

Tooling
Check our list of old tooling that used to be available for this part